

H7N0310LD, H7N0310LS, H7N0310LM

Silicon N Channel MOS FET **High Speed Power Switching**

REJ03G1125-0500 (Previous: ADE-208-1422C)

Rev.5.00

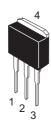
Apr 07, 2006

Features

- Low on-resistance
 - $R_{DS (on)} = 8 \text{ m}\Omega \text{ typ.}$
- Low drive current

Outline

RENESAS Package code: PRSS0004AE-A (Package name: LDPAK (L))



H7N0310LD

RENESAS Package code: PRSS0004AE-C (Package name: LDPAK (S)-(2))



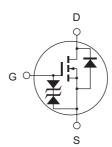
H7N0310LM

RENESAS Package code: PRSS0004AE-B (Package name: LDPAK (S)-(1))



H7N0310LS

- 1. Gate 2. Drain
- 3. Source
- 4. Drain



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit	
Drain to source voltage	V_{DSS}	30	V	
Gate to source voltage	V_{GSS}	±20	V	
Drain current	I _D	30	Α	
Drain peak current	I _{D (pulse)} Note 1	120	Α	
Body to drain diode reverse drain current	I_{DR}	30	Α	
Channel dissipation	Pch Note 2	50	W	
Channel to case thermal impedance	θ ch-c	2.5	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

www.DataShee Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%

2. Value at Tc = 25°C

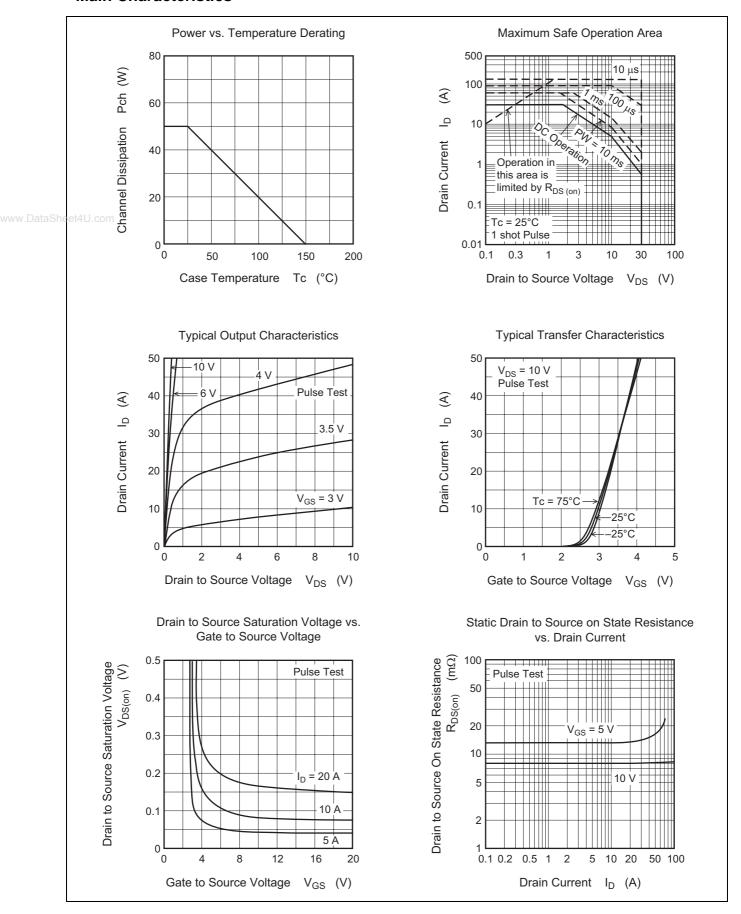
Electrical Characteristics

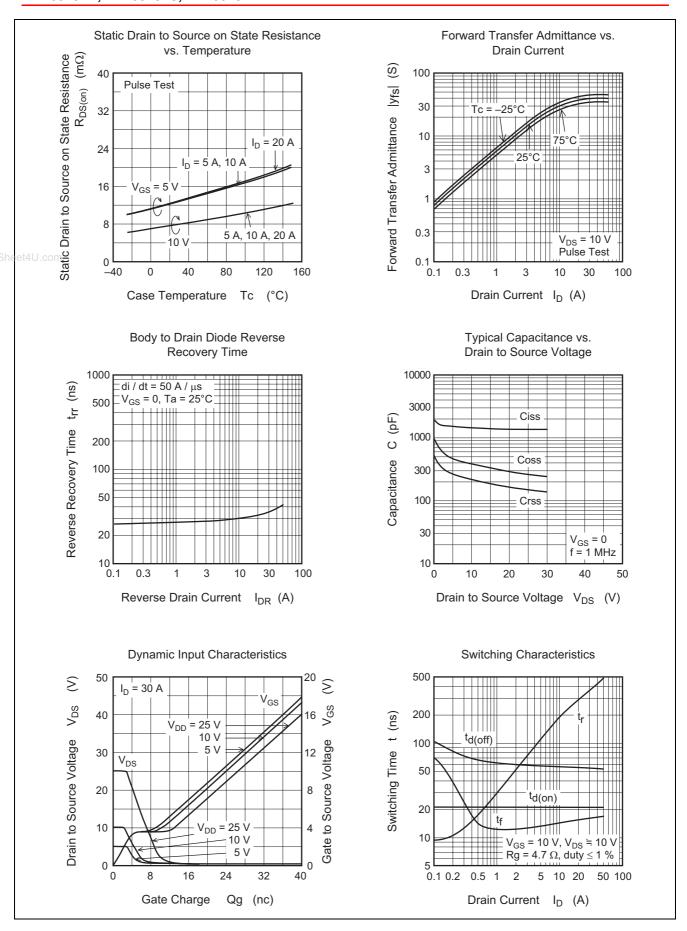
 $(Ta = 25^{\circ}C)$

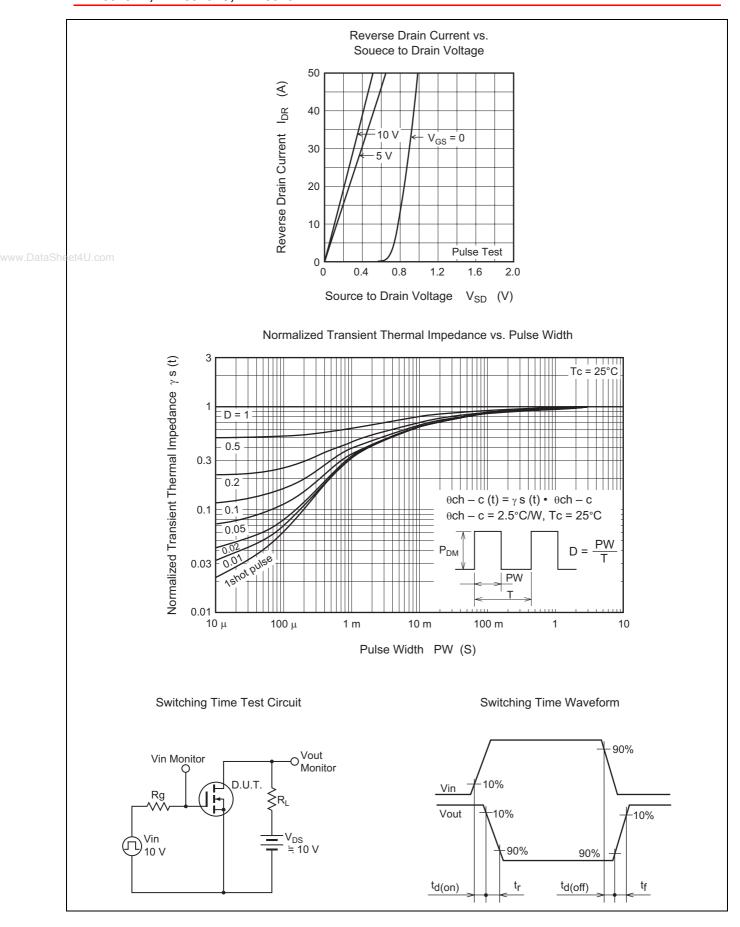
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	_	_	V	$I_G = \pm 100 \mu\text{A}, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0	_	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Static drain to source on state	R _{DS (on)}	_	8.0	10	mΩ	$I_D = 15 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 3}}$
resistance		_	13	19	mΩ	$I_D = 15 \text{ A}, V_{GS} = 5 \text{ V}^{\text{Note 3}}$
Forward transfer admittance	y _{fs}	21	35	_	S	$I_D = 15 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Input capacitance	Ciss	_	1400	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	380	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	210	_	pF	f = 1 MHz
Total gate charge	Qg	_	24	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs	_	4.8	_	nC	V _{GS} = 10 V
Gate to drain charge	Qgd	_	4.6	_	nC	$I_D = 30 \text{ A}$
Turn-on delay time	t _{d (on)}	_	21	_	ns	V _{GS} = 10 V, I _D = 15 A
Rise time	t _r	_	250	_	ns	$R_L = 0.67 \Omega$
Turn-off delay time	t _{d (off)}	_	55	_	ns	$Rg = 4.7 \Omega$
Fall time	t _f	_	16	_	ns	
Body to drain diode forward voltage	V_{DF}	_	0.90	_	V	$I_F = 30 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery	t _{rr}	_	35	_	ns	$I_F = 30 \text{ A}, V_{GS} = 0$
time						di _F /dt = 50 A/μs

Note: 3. Pulse test

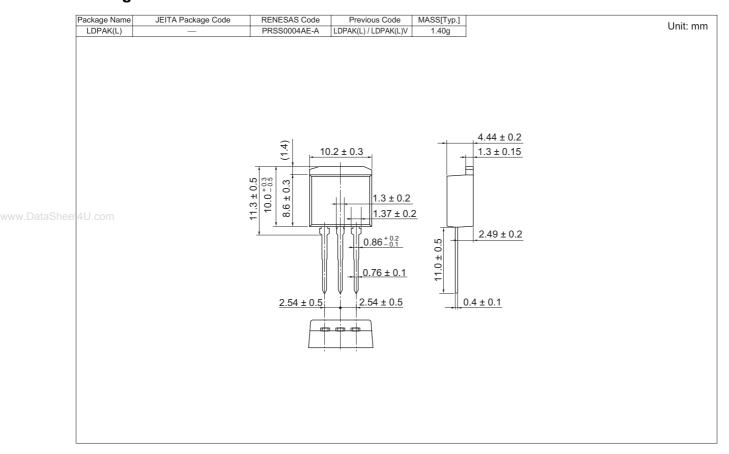
Main Characteristics

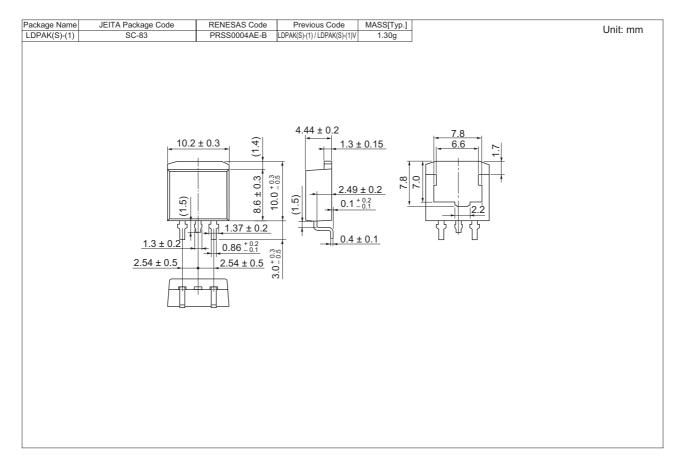


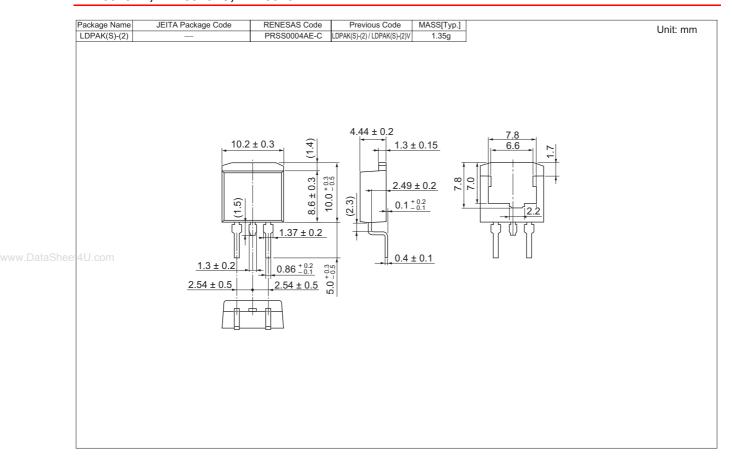




Package Dimensions







Ordering Information

Part Name	Quantity	Shipping Container	
H7N0310LD-E	500 pcs	Box (Conductive Sack)	
H7N0310LSTL-E	1000 pcs	Taping	
H7N0310LMTL-E	1000 pcs	Taping	

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